

SILICON CARBIDE SCHOTTKY DIODE

Reverse Voltage - 1200 Volts Forward Current - 15 Amperes

DESCRIPTION

SiC Schottky Diode has no switching loss, provides improved system efficiency against Si diodes by utilizing new semiconductor material-Silicon Carbide, enables higher operating frequency, and helps increasing power density and reduction of system size /cost. Its high reliability ensures robust operation during surge or over_voltage conditions.

FEATURES

- Max Junction Temperature 175°C
- High Surge Current Capacity
- Positive Temperature Coefficient
- Ease of Paralleling
- No Reverse Recovery/No Forward Recovery

MECHANICAL DATA

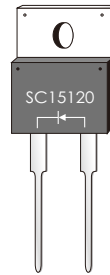
- Case: JEDEC TO-220AC/ITO-220AC/TO-263AC/TO-252AC
- Molding compound meets UL94V-0 flammability rating
- Terminals: Lead solderable per J-STD-002 and JESD22-B102
- Polarity: As marked
- Mounting Torque: 10 in-lbs maximum

TYPICAL APPLICATIONS

- General Purpose
- SMPS, Solar inverter, UPS
- Power Switching Circuits

TO-220AC

KWSC15120



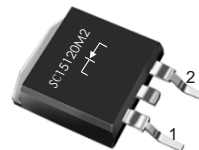
ITO-220AC

KWSC15120F



TO-252

KWSC15120M2



TO-263AC

KWSC15120D2



KEY PERFORMANCE AND PACKAGE PARAMETERS

Type	V _{DC}	I _F	Q _c	T _{J,max}	Package
KWSC15120	1200V	15A	48nC	175°C	TO-220AC
KWSC15120F	1200V	15A	48nC	175°C	ITO-220AC
KWSC15120D2	1200V	15A	48nC	175°C	TO-263AC
KWSC15120M2	1200V	15A	48nC	175°C	TO-252AC

MAXIMUM RATINGS

(Ratings at 25° C ambient temperature unless otherwise specified)

Parameter	Symbol	Value	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	1200	V
Continuous Forward Current for $R_{th(j-c)}$	I_F	15 ($T_c \leq 138^\circ\text{C}$ TO-220/TO-263) 15 ($T_c \leq 100^\circ\text{C}$ TO-252/ITO-220)	A
Non-Repetitive Forward Surge Current (Half-Sine Pulse, $t_p = 8.3\text{ms}$)	$I_{F,SM}$	135 (25°C) 125 (150°C)	A
I^2t value	$\int I^2 t$	75 (25°C) 64 (150°C)	A^2S
Diode dv/dt ruggedness ($V_R = 0 \dots 650\text{V}$)	dv/dt	80	V/nS
Power dissipation for $R_{th(j-c,max)}$ ($T_c = 25^\circ\text{C}$)	P_{tot}	125 (TO-220/TO-263) 60 (TO-252/ITO-220)	W
Operating junction temperature range	T_j	-55...175	$^\circ\text{C}$
Storage temperature range	T_{stg}	-55...175	$^\circ\text{C}$

THERMAL CHARACTERISTICS ($T_A = 25^\circ\text{C}$ Unless otherwise noted)

Parameter	Symbol	ITO-220AC	TO-220AC	TO-263AC	TO-252AC	Unit
Diode thermal resistance junction-case	$R_{th(j-c)}$	2.5	1.2	1.2	2.5	K/W

ELECTRICAL CHARACTERISTICS (T_A=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Value			Unit
			min	typ	max	
DC blocking voltage	V _{DC}	T _j =25...175°C	1200			V
Diode forward voltage	V _F	IF=10A T _j =25°C IF=10A T _j =125°C IF=10A T _j =175°C		1.57 2.2 2.25	1.8 2.5 2.5	V
Reverse current	I _R	VR=1200V T _j =25°C VR=1200V T _j =125°C VR=1200V T _j =175°C			20 100 200	uA

DYNAMIC CHARACTERISTICS (at T_j=25°C, unless otherwise specified)

Parameter	Symbol	conditions	Value			Unit
			min	typ	max	
Total capacitive charge	Q _c	VR=1200V, IF=5A di/dt=200A/uS T _j =25°C		48		nC
Total capacitance	C	V _R =0V, f=1MHz V _R =400V, f=1MHz V _R =800V, f=1MHz T _j =25°C		940 70 57		pF

FIG.1-FORWARD CURRENT DERATING CURVE

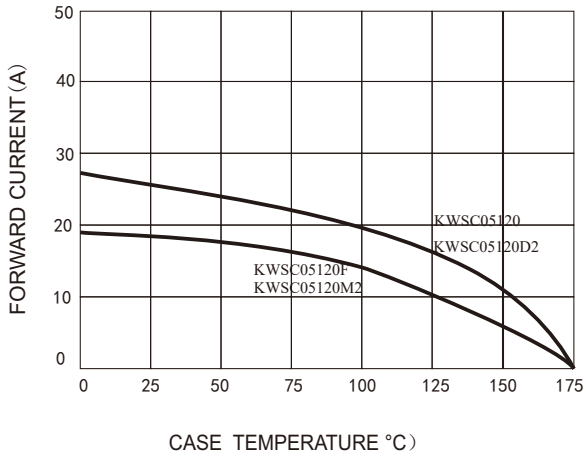


FIG.2-TYPICAL JUNCTION CAPACITANCE

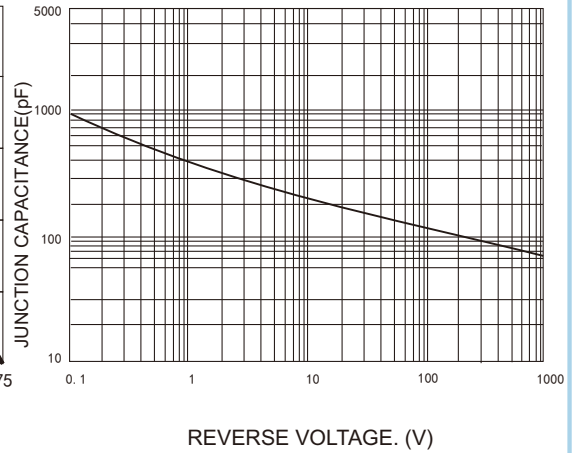


FIG.3-FORWARD CURRENT DERATING CURVE

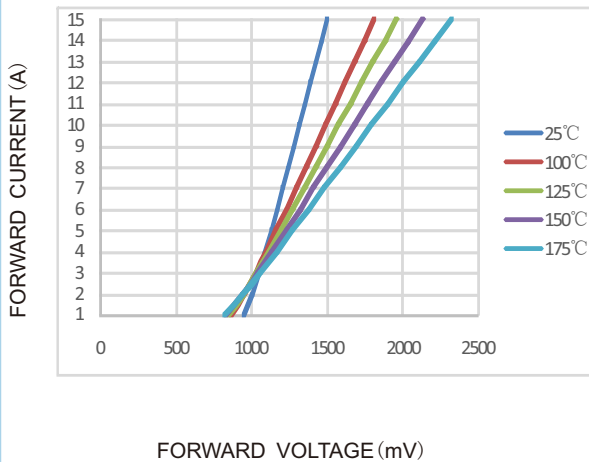
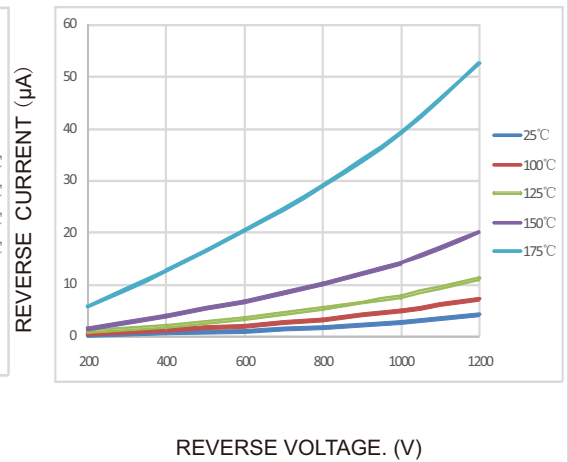
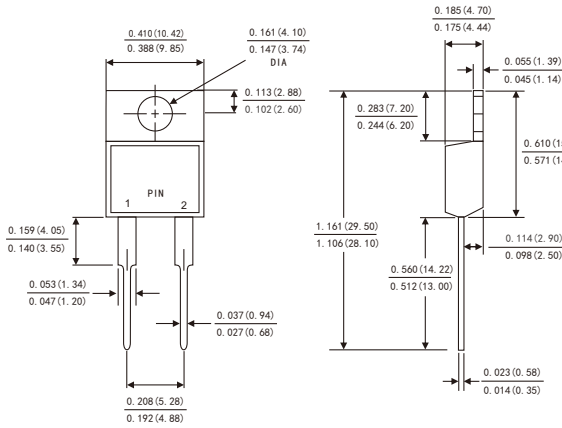


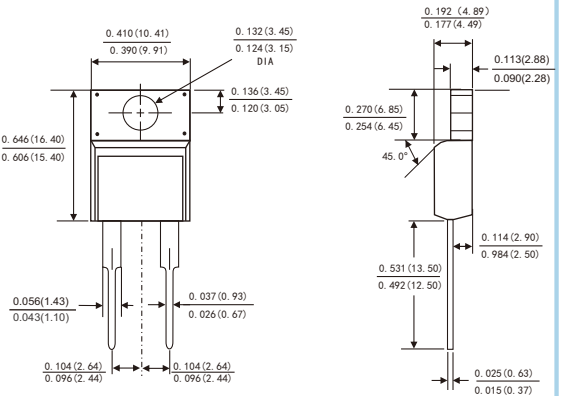
FIG.4-REVERSE CHARACTERISTICS



TO-220AC



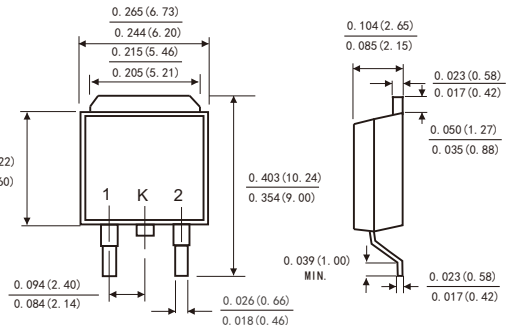
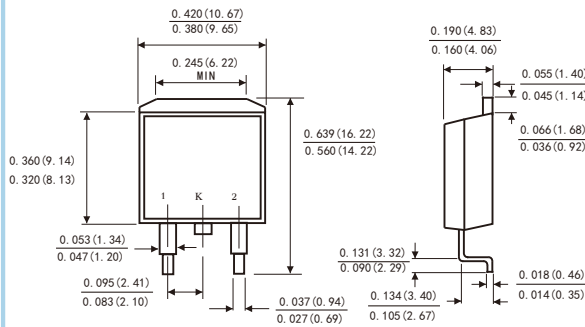
ITO-220AC



Dimensions in inches and (millimeters)

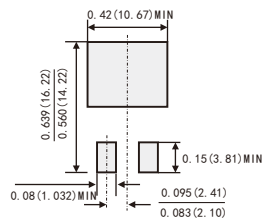
Dimensions in inches and (millimeters)

TO-263



Suggested Pad Layout

(TO-263)



TO-252

Suggested Pad Layout

(TO-252)

